

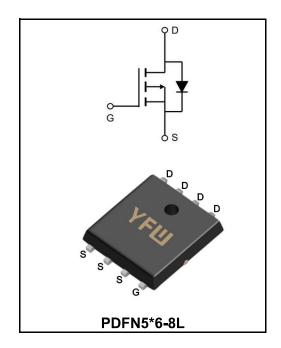
## -100V P-CHANNEL ENHANCEMENT MODE MOSFET

### **MAIN CHARACTERISTICS**

I <sub>D</sub>	-30A			
$V_{ exttt{DSS}}$	-100V			
R <sub>DSON</sub> -typ(@V <sub>GS</sub> =-10V)	< 95mΩ <b>(Type:68 mΩ)</b>			

### **Application**

- ♦Brushless motor
- **♦**Load switch
- ♦Uninterruptible power supply



# Maximum Ratings at Tc=25°C unless otherwise specified

Characteristics	Symbols	Value	Units
Drain-Source Voltage	V <sub>DS</sub>	-100	V
Gate - Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1</sup> @T <sub>C</sub> =25℃	I <sub>D</sub>	-30	Α
Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1</sup> @T <sub>C</sub> =100°C	I <sub>D</sub>	-18	Α
Pulsed Drain Current <sup>2</sup>	I <sub>DM</sub>	-90	Α
Single Pulse Avalanche Energy <sup>3</sup>	E <sub>AS</sub>	157.2	mJ
Avalanche Current	las	-19	Α
Total Power Dissipation⁴ @T <sub>C</sub> =25°C	P <sub>D</sub>	280	w
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C
Operating Junction Temperature Range	TJ	-55 to +150	°C
Thermal Resistance Junction-Ambient <sup>1</sup>	R <sub>0JA</sub>	25	°C/W
Thermal Resistance Junction-Case <sup>1</sup>	R <sub>eJC</sub>	2.3	°C/W





## Maximum Ratings at Tc=25°C unless otherwise specified

Characteristics	Test Condition	Symbols	Min	Тур	Max	Units	
Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA	BV <sub>DSS</sub>	-100	-	-	V	
Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-10A		-	68	95	mΩ	
	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-8A	R <sub>DS(ON)</sub>	-	78	110		
Gate -Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA	V <sub>GS(th)</sub>	-1.2	-1.7	-2.5	V	
Drain-Source Leakage Current	V <sub>DS</sub> =-100V , V <sub>GS</sub> =0V , T <sub>J</sub> =25℃	I <sub>DSS</sub>	-	-	-50	μА	
Gate –Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	I <sub>GSS</sub>	-	-	±100	nA	
Forward Transconductance	V <sub>DS</sub> =-10V , I <sub>D</sub> =-10A	g <sub>fs</sub>	-	24	-	S	
Total Gate Charge	V = 50V	Qg	-	44.5	-		
Gate-Source Charge	V <sub>DS</sub> =-50V V <sub>GS</sub> =-10V	Q <sub>gs</sub>	-	9.13	-	nC	
Gate-Drain Charge	- I <sub>D</sub> =-20A	$\mathbf{Q}_{\mathrm{gd}}$	-	5.93	-		
Turn-on delay time	$V_{DD}$ =-50V $V_{GS}$ =-10V $I_{D}$ = -10A $R_{G}$ = 3.3	<b>t</b> d(on)	-	12	-		
Rise Time		Tr	-	27.4	-		
Turn-Off Delay Time		<b>t</b> d(OFF)	-	79	-	- ns	
Fall Time	- NG-5.5	t <sub>f</sub>	-	53.6	-		
Input Capacitance	- V <sub>DS</sub> =-20V	C <sub>iss</sub>	-	3029	-		
Output Capacitance	V <sub>GS</sub> =0V	C <sub>oss</sub>	-	129	-	PF	
Reverse Transfer Capacitance	f=1MHz	C <sub>rss</sub>	-	76	-		
Continuous Source Current <sup>1.5</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current	Is	-	-	-30	А	
Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25℃	V <sub>SD</sub>	-	-	-1.2	v	
Reverse Recovery Time		t <sub>rr</sub>	-	38.7	-	ns	
Reverse Recovery Charge	- I <sub>F</sub> =-8A, dI/dt=100A/μs, T <sub>J</sub> =25℃	Q <sub>rr</sub>	-	22.4	-	nC	

#### Note:

- $1_{\times}$  The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3、The EAS data shows Max. rating . The test condition is V DD =-72V,VGS =-10V,L=0.1mH,IAS =-19A
- 4. The power dissipation is limited by 150°C junction temperature
- $5\sqrt{100}$  The data is theoretically the same as I D and I DM , in real applications , should be limited by total power dissipation.

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### **Ratings and Characteristic Curves**

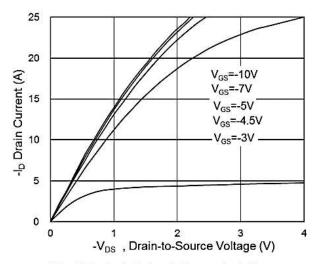


Fig.1 Typical Output Characteristics

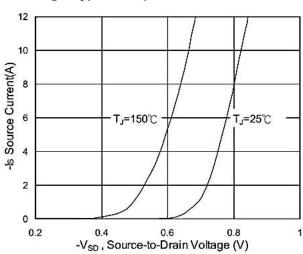


Fig.3 Typical S-D Diode Forward Voltage

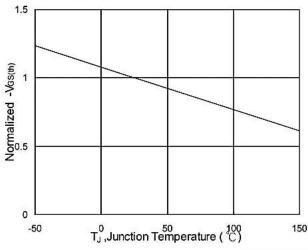


Fig.5 Normalized V<sub>GS(th)</sub> vs T<sub>J</sub>

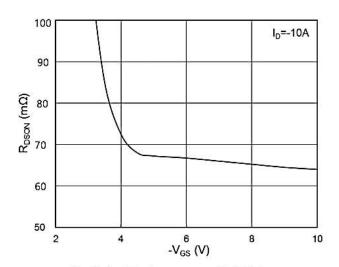


Fig.2 On-Resistance vs G-S Voltage

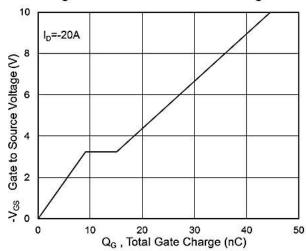


Fig.4 Gate-Charge Characteristics

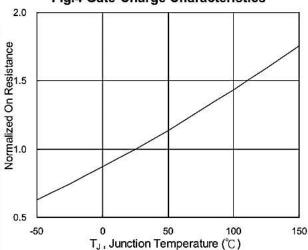
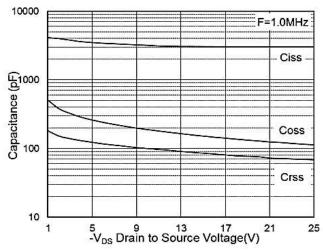


Fig.6 Normalized RDSON vs TJ



#### **Ratings and Characteristic Curves**



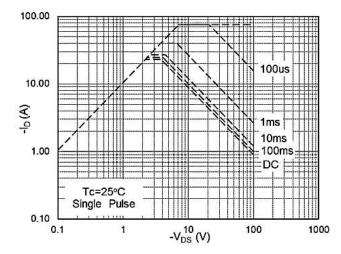


Fig.7 Capacitance



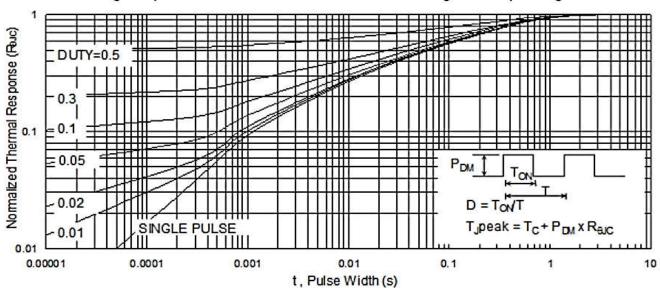


Fig.9 Normalized Maximum Transient Thermal Impedance

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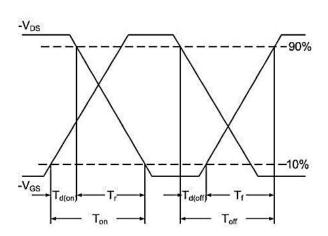


Fig.10 Switching Time Waveform

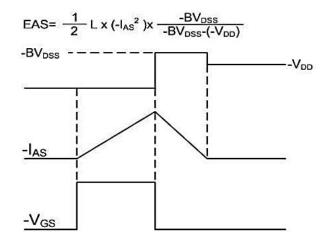
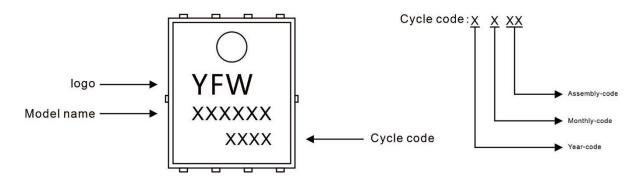


Fig.11 Unclamped Inductive Waveform



### **Marking Diagram**

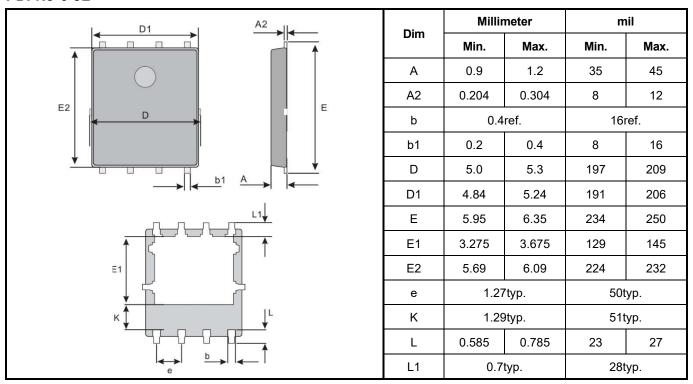


# **Ordering information**

Model name	Package	Unit Weight	Base Quantity	Packing Quantity
YFW30P10NF	PDFN5*6-8L	0.0032oz(0.093g)	5000pcs/reel	10000pcs/box 50000pcs/Carton

## **Package Dimensions**

#### PDFN5\*6-8L





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